Detectors



Ties Behnke, DESY

Status of the field

LHC commissioning

- Future Projects and Directions
- Conclusions and Outlook

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Today

- LHC is "about" to start, but Detector development finished
- Major R&D projects are on the horizon: sLHC, ILC
- Physics prospects are exciting and challenging
- Both accelerator based and non-accelerator based experiments push the limits of what can be done

Accelerator technology is advancing rapidly Detectors are critical if we are to fully utilize our capabilities

R&D is driven by the physics program and requirements

LHC: the near Future

Detector Commissioning at the LHC is in full swing / close to finished



ATLAS Installation

- Pixel Package Lowered; 25 June
- Pixel Package Installed; 29 June





ATLAS installation is well advance Integration and commissioning is proceeding Intend to be ready when LHC turns on

A. Andreazza, F. Tarrade, D. Damazzio, C.Schmitt, T. Goettfert, F. Petrucci, P. Miyagawa, A. Nairz, T. Pauly, R. Gonzalo

CMS Installation





Detector successfully installed in cavern Tracker, calorimeter barrel installed Pixel soon to come Endcap calorimeter under construction



A. Satpathy, C. Wulz, RM Brown, W. Erdmann, S. Malik, M. Fernandez-Garcia, T. Boccali, A. Oh, P. Bargassa, H. Sakulin, I. Tomalin

LHCb Installation



VELO Installation/ Status



Rich in the cavern

6

Calorimeter

H. Terrier, O. Behrendt, U. Kerzel, F. Macherfert, C. Parkes,

The Challenges now:

Commissioning (integration of many systems, common DAQ, data handling...)

Concerns hardware and software

Event display from cosmic run with combined calorimeters in ATLAS





Much more in parallel session talks

Future Projects





Technology trends

Technology enables advances in detectors



Pixel cell for SI-pixel based ECAL (N. Watson)

Segmentation

- Small pixel sizes
- Small cell large volume calorimeters
- * Advanced gas detectors
- Speed
 - Faster, higher bandwidth
 - Low noise
 - Low power
- Feature size/ Integration
 - Cutting edge technologies
 - Functionality moves into the front end
- Materials
 - Novel materials: thin detectors
 - Optimized mechanical integration

Segmentation

A global trend: larger and larger segmentation

LHC/ sLHC: deal with large occupations and backgrounds

ILC:

need extreme precision deal with backgrounds (Vertex Detector) do "tracking with a calorimeter"

ILC examples of proposed granularity:

- Silicon Tungsten Calorimeter
- Vertex Detector

9x10⁷ cells (5x5 mm2) 9x10⁹pixels (20x20 µm2)

Without the technology the physics will suffer

Driven by technology: price ~ area, not # of channels

Speed/ Power

- Speed is often a critical parameter
 - SLHC: event pile-up, background rates
 - ILC: Background close to IP, bunch structure
 - Super B Factory: similar issue
- Power is closely related to that
 - "Power in Heat out"
 - Particularly important for large number of channel systems
 - Important design consideration with potentially large consequences



Material

RVC foam (foam thickness 1.5 mm)

Silicon Carbide foam (foam thickness 1.5 mm)

12

Low material detectors are of central importance for many applications

Skilled engineering becomes a major asset/ problem/ requirement

Estimated material budget for a ILC



Materials: from Concept to Reality

Major difference / advance to LHC detectors is needed:





13

sLHC Detector Challenges

Radiation

 $-10^{16}/cm^{2} @ r = 5 cm(400 MRad) \\ -10^{15}/cm^{2} @ r = 20 cm(40 MRad) \\ -2 \times 10^{14}/cm^{2} @ r = 50 cm(10 MRad)$

-> Technology

Pileup

200 interactions / crossing $dN_{ch}/d\eta(\eta=0)=1500$

-> Geometry



I. Dawson

Huge number of forward-going tracks, mostly low pt

The biggest challenge is for the tracker CMS

SLHC Tracking issues

Radiation is main concern:

- radiation hardness
- occupancies

SI-strip detectors:

OK for r>60 cm, pitch of 80-160µm need to operate at 2xLHC tested fluences

"Standard" pixel detectors

Can work between 20cm < r < 60 cm through pixel size = 1/10 current strip cell, 10 times current pixel size

New technology pixel

Feature size 50µm×50µm many ideas: CVD diamond, monolithic pixel, ...

Silicon R&D for sLHC

Required:

Silicon sensors able to withstand up to six times the LHC radiation doses.

For pixels at r \geq 10cm: require survival to $\sim 6 \times 10^{15} n_{eq}/cm^2$

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(~10<sup>16</sup>p/cm<sup>2</sup>) with Signal/Noise > 10.
(RD50)
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Short strip (1cm) prototype detector



Efficiency for different radiation doses

For the innermost layers:

CVD diamond? Maybe Gas (micromegas)? ¹⁶

ILC Detector Challenges

Precision physics in a "low" radiation environment

Pixel vertex detectors high precision tracking excellent jet mass resolution

Detailed event reconstruction





ILC Vertex Detector Concepts



VTX Technologies

- Column Parallel CCD: 50MHz (10cm inner layer read-out both ends)
- DEPFET: low noise deep depletion device 22.5×36µm
- CMOS MAPS: 20 columns of 5mm depth (256 20µm active pixels) at 10MHz
- FAPS: in-pixel memory (but compromise # cells and pixel area)
 - CCD: in-pixel memory (ISIS) (limited vendors for 20×20µm pixels)
 - SoI: deep depletion substrate with vias to CMOS circuitry
 - 3D: industrial process multi-tier approach allows mix of technologies
- size

readout

store

- FPCCD: 5µm×5µm pixels read out between bunch trains
- CMOS: 5µm×5µm micro-pixels integrated with 50µm×50µm macro-pixels Wide variety of technologies are under study
 Very active field, lots of progress in the past years

Large overlap with other projects: STAR upgrade, Super B, sLHC: room for common effort? European program under FP7?

Very incomplete list of projects

Vertexing Technologies

MAPS technology

- Active pixel (on pixel electronics)
- Thin sensitive layer: back-thinning
- Radiation tolerant:
 - X-rays tested to few 100 kRad
 - Neutrons tested to 10^13 n(eq)/cm2



Application of MAPS technology in STAR upgrade, Belle upgrade



Designer's Dream



Wafer thinned to 50 microns (leti)

Very incomplete list of projects

Vertexing Technologies

Low noise, low power technology: DEPFET

- Fully depleted sensitive layer
- Internal amplification
- Powered only during readout, not during charge collection



Charge storage in the pixel: ISIS, CCD, FAPS...

 Ideal for ILC: fast sensing, relaxed reading
 Little sensitivity to EMI



Tracking technologies: SI tracking



Silicon strip detector developments:

material budget

light support structures

control of thermal load

Proposed forward SI tracking system for LDC





Integrate readout into detector to minimise material

Tracking technologies: TPC



GEM

Tracking technologies: TPC

Event recorded at B = 0.2T in Ar (95%) iC₄H₁₀ (2%) CF₄

(3%)

Gas amplification by Micro Pattern Gas Detector



TPC goes Silicon

Amplification



Bulk Micromegas:

SI fabrication techniques are used to create gas amplification structures

Readout

MediPix chip mounted in place of the pad plane: pixel readout 50µm × 50µm



"electronic bubble chamber"

TPC goes Silicon

Amplification



Bulk Micromegas:

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Readout

MediPix chip mounted in place of the pad plane: pixel readout 50µm × 50µm



"electronic bubble chamber"

The Future of Tracking at the ILC

TPC based tracker with SI

All-SI tracker



Robust, redundant point resolution gas + SI technology mixture speed Robust, few points point resolution single technology speed

The discussion is ongoing, no clear favorite

Particle Flow

Type E/E_{tot} RMS 26.55 19.33 Most precise event reconstruction NH 3 200 6 632 Neutral (measured e.g. in the jet mass) Individual particles are reconstructed: EN Charged charged and neutrals Hadrons Fundamental problem: fluctuations in the calorimeter: **<70%>** use tracker as much as possible replace information in calo by tracker information only use calo for neutral particles (photons, neutral hadrons) Pushes requirements for calorimeter: 30%/JE (below 100 GeV) excellent segmentation is the goal

energy resolution is of lesser importance

Particle Flow in Simulation



Simulation of an event

Resolution close to 30%/√E for jets below 100 GeV

Particle flow gives ~2x better performance than traditional approach (<100 GeV jets)

Software is an important part of the detector optimization and development

Si-W ECAL developments

Typical granularity for ECAL: 0.5cmx0.5cm to 1cmx1cm, SI detectors, Tungsten absorbers





Allows "tracking" in the calorimeter Extreme direction: MAPS sensors in the ECAL



Very detailed shower images 30

HCAL developments

HCAL plays crucial role in a particle flow calorimeter

Simulation of hadronic shower is problematic

Typical cell sizes $3 \times 3 \text{ cm}^2$ with analogue readout

Digital option investigated (smaller cells, 1bit readout)







Major effort (CALICE) to protoype such a calorimeter for the ILC

ECAL/ HCAL Test Beam (CALICE)

Major effort to test

- Technologies
- Shower physics

Combined ECAL/ HCAL/ Tailcatcher test beam at CERN (2006/7) FNAL (2007/8)



2 track event recorded at the CERN test beam

with reconstruction run on the data

ECAL/ HCAL Test Beam (CALICE)

Major effort to test

- Technologies
- Shower physics

Combined ECAL/ HCAL/ Tailcatcher test beam at CERN (2006/7) FNAL (2007/8)



2 track event recorded at the CERN test beam

with reconstruction run on the data

Several Tbyte of data recorded at different E for pion, electron, muon

DREAM technology

Dual readout calorimeter:

- Scintillator and Cerenkov fibers
- Sensitivities to EM and had part are different

Good energy resolution possible compensation by software "easy" segmentation is difficult, in particular in depth

Is this an alternative to the "particle flow" calorimeters?



Detectors at the ILC

Four detector concepts at the ILC



Outlook and Conclusion

Detector Developments is an active and fascinating field



40 talks in parallel session (D. Newbold, I. Winterer) LHC commissioning LHC data handling and computing R&D projects (ILC, sLHC, SuperB, STAR, MICE, ...)

apologies for those topics not covered in this talk

36

Continuing advances in detector technology are central to the continued vitality of out field

(remark: test beams are important!)

Technology makes new approach possible: SI-TPC, particle flow calorimeter, ... Technology will be central to the success of the current and future projects